# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

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Name	Execution Date
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### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16922257

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DATE SIGNED:	12/19/2023

## **Total Attachments: 2**

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PATENT 508291158 REEL: 065906 FRAME: 0493

# COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

#### DECLARATION

As a below-named	inventor, I hereby declare that this	declaration is directed to the application attached hereto,
or to United States	Application Number or PCT Intern	ational Application Number
<i></i>	filed on	(if applicable), entitled:
	NTELLIGENCE (AI) ACCELER	METHOD OF INTERCONNECT DEVICE, AND NATOR SYSTEM INCLUDING INTERCONNECT EVICE
The above-identifie	d application was made or authoriz	zed to be made by me.
believe I am the o application.	riginal inventor or an original joint i	inventor of a claimed invention in the above-identified
	ge that any willful false statement risonment of not more than five (5)	made in this declaration is punishable under 18 USC ) years, or both.
I have reviewed and	d understand the contents of the a	bove-identified application, including the claims.
me to be material to material information	patentability as defined in 37 CFF	s Patent and Trademark Office all information known to R 1.56, including for continuation-in-part applications, he filing date of the prior application and the national or t application.
	ASSIC	Эимеит
For valuable consid	leration, I, as a below-named assig	gnor, hereby assign to:
129, Samsi	ilectronics Co., Ltd. ung-ro, Yeongtong-gu 3yeonggi-do 16677 Korea	
and its successors	and assigns (collectively hereinafte	er called "the Assignee"), the entire right, title, and
interest throughout	the world in the inventions and imp	provements that are the subject of the application
	ve declaration, which is United Sta 2,257 filed on	ates Application Number or PCT International Application July 7, 2020
I authorize and requ Assignment by inse	uest the attorneys appointed in the rting above the application numbe	above-identified application to hereafter complete this or and the filing date of the above-identified application that may be discovered in this Assignment.
utility models, and c subject of the above	lesign registrations granted for any e-identified application, and the rigi	ution, any and all United States and foreign patents, y of the inventions and improvements that are the ht to claim priority based on the filing date of the above- on for the Protection of Industrial Property, the Patent

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Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements

that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such

## COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	Yongha PARK	
Inventor's Signature	Jane, 22, 2020	
Residence (City, Country)	Séongnam-si, Republic of Korea	
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